



## TE0817 Test Board

Revision v.5

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Online version of this document:

<https://wiki.trenz-electronic.de/display/PD/TE0817+Test+Board>

# 1 Table of Contents

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1	Table of Contents .....	2
2	Table of Figures .....	4
3	Table of Tables .....	5
4	Overview .....	7
4.1	Key Features .....	7
4.2	Revision History .....	7
4.3	Release Notes and Know Issues .....	7
4.4	Requirements .....	8
4.4.1	Software .....	8
4.4.2	Hardware .....	8
4.5	Content .....	9
4.5.1	Design Sources .....	9
4.5.2	Additional Sources .....	10
4.5.3	Prebuilt .....	10
4.5.4	Download .....	11
5	Design Flow .....	12
6	Launch .....	14
6.1	Programming .....	14
6.1.1	Get prebuilt boot binaries .....	14
6.1.2	QSPI-Boot mode .....	14
6.1.3	SD-Boot mode .....	14
6.1.4	JTAG .....	14
6.2	Usage .....	15
7	System Design - Vivado .....	16
7.1	Block Design .....	16
7.1.1	PS Interfaces .....	16
7.2	Constraints .....	17
7.2.1	Basic module constraints .....	17
7.2.2	Design specific constraints .....	17
8	Software Design - Vitis .....	18
8.1	Application .....	18
8.1.1	zynqmp_fsbl .....	18
8.1.2	zynqmp_fsbl_flash .....	18
8.1.3	hello_te0817 .....	18
9	Additional Software .....	19
10	App. A: Change History and Legal Notices .....	20
10.1	Document Change History .....	20
10.2	Legal Notices .....	20
10.3	Data Privacy .....	20
10.4	Document Warranty .....	20

10.5	Limitation of Liability .....	20
10.6	Copyright Notice .....	21
10.7	Technology Licenses.....	21
10.8	Environmental Protection .....	21
10.9	REACH, RoHS and WEEE .....	21

## 2 Table of Figures

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Figure 1: Block Design .....16

### 3 Table of Tables

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Table 1: Design Revision History ..... 7

Table 2: Known Issues..... 8

Table 3: Software ..... 8

Table 4: Hardware Modules..... 9

Table 5: Hardware Carrier..... 9

Table 6: Additional Hardware..... 9

Table 7: Design sources ..... 9

Table 8: Additional design sources ..... 10

Table 9: Prebuilt files (only on ZIP with prebuilt content) ..... 10

Table 10: PS Interfaces..... 16

Table 11: Document change history. .... 20



## 4 Overview

Refer to <http://trenz.org/te0817-info> for the current online version of this manual and other available documentation.

### 4.1 Key Features

- Vitis/Vivado 2021.2.1
- QSPI
- Custom Carrier (minimum PS Design with available module components only)
- Modified FSBL (some additional outputs only)

### 4.2 Revision History

Date	Vivado	Project Built	Authors	Description
2022-09-12	2021.2.1	TE0817-test_board-vivado_2021.2-build_15_20220912093808.zip TE0817-test_board_noprebuilt-vivado_2021.2-build_15_20220912093808.zip	Manuela Strücker	<ul style="list-style-type: none"><li>• update board part file compatible to Vivado 2021.2.1</li></ul>
2022-06-27	2021.2	TE0817-test_board-vivado_2021.2-build_14_20220627122123.zip TE0817-test_board_noprebuilt-vivado_2021.2-build_14_20220627122123.zip	Manuela Strücker	<ul style="list-style-type: none"><li>• initial release</li></ul>

**Table 1: Design Revision History**

### 4.3 Release Notes and Know Issues

Issues	Description	Workaround	To be fixed version
Xilinx Software	Incompatibility of board files for ZynqMP with eMMC activated between 2021.2 and 2021.2.1 patch, see <a href="#">Xilinx Forum Request</a> <sup>1</sup>	use corresponding board files for the Vivado versions	--

**Table 2: Known Issues**

## 4.4 Requirements

### 4.4.1 Software

Software	Version	Note
Vitis	2021.2.1	needed, Vivado is included into Vitis installation
PetaLinux	2021.2	needed
SI ClockBuilder Pro	---	optional

**Table 3: Software**

### 4.4.2 Hardware

Basic description of TE Board Part Files is available on [TE Board Part Files](#).<sup>2</sup>

Complete List is available on "<project folder>\board\_files\\*\_board\_files.csv"

Design supports following modules:

<sup>1</sup> [https://support.xilinx.com/s/feed/0D54U00005Wbon6SAB?language=en\\_US](https://support.xilinx.com/s/feed/0D54U00005Wbon6SAB?language=en_US)

<sup>2</sup> <https://wiki.trenz-electronic.de/display/PD/TE+Board+Part+Files>



Module Model	Board Part Short Name	PCB Revision Support	DDR	QSPI Flash	EMMC	Others	Notes
TE0817-01-7 DE21-A*	7ev_1e_4gb	REV01	4GB	128MB	NA	NA	NA

**Table 4: Hardware Modules**

\*used as reference

Design supports following carriers:

Carrier Model	Notes
TEBT0818	
TEBF0818*	

**Table 5: Hardware Carrier**

\*used as reference

Additional HW Requirements:

Additional Hardware	Notes

**Table 6: Additional Hardware**

\*used as reference

## 4.5 Content

For general structure and usage of the reference design, see [Project Delivery - Xilinx devices](https://wiki.trenz-electronic.de/display/PD/Project+Delivery+-+Xilinx+devices)<sup>3</sup>

### 4.5.1 Design Sources

Type	Location	Notes
Vivado	<project folder>\block_design <project folder>\constraints	Vivado Project will be generated by TE Scripts

<sup>3</sup> <https://wiki.trenz-electronic.de/display/PD/Project+Delivery+-+Xilinx+devices>

Type	Location	Notes
	<project folder>\ip_lib <project folder>\board_files	
Vitis	<project folder>\sw_lib	Additional Software Template for Vitis and apps_list.csv with settings automatically for Vitis app generation

**Table 7: Design sources**

#### 4.5.2 Additional Sources

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Type	Location	Notes
---	---	---

**Table 8: Additional design sources**

#### 4.5.3 Prebuilt

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File	File-Extension	Description
BIF-File	*.bif	File with description to generate Bin-File
BIN-File	*.bin	Flash Configuration File with Boot-Image (Zynq-FPGAs)
BIT-File	*.bit	FPGA (PL Part) Configuration File
DebugProbes-File	*.ltx	Definition File for Vivado/Vivado Labtools Debugging Interface
Diverse Reports	---	Report files in different formats
Hardware-Platform-Description-File	*.xsa	Exported Vivado <a href="#">hardware description file</a> for Vitis and PetaLinux
LabTools Project-File	*.lpr	Vivado Labtools Project File

File	File-Extension	Description
Software-Application-File	*.elf	Software Application for Zynq or MicroBlaze Processor Systems

**Table 9: Prebuilt files (only on ZIP with prebuilt content)**

#### 4.5.4 Download

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Reference Design is only usable with the specified Vivado/Vitis/PetaLinux version. Do never use different Versions of Xilinx Software for the same Project.

Reference Design is available on:

- [TE0817 "Test Board" Reference Design](#)<sup>4</sup>

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<sup>4</sup> [https://shop.trenz-electronic.de/Download/?path=Trenz\\_Electronic/Modules\\_and\\_Module\\_Carriers/5.2x7.6/TE0817/Reference\\_Design/2021.2/test\\_board](https://shop.trenz-electronic.de/Download/?path=Trenz_Electronic/Modules_and_Module_Carriers/5.2x7.6/TE0817/Reference_Design/2021.2/test_board)

## 5 Design Flow

**!** Reference Design is available with and without prebuilt files. It's recommended to use TE prebuilt files for first launch.

Trenz Electronic provides a tcl based built environment based on Xilinx Design Flow.

See also:

- [AMD Development Tools](#)<sup>5</sup>
- [Vivado Projects - TE Reference Design](#)<sup>6</sup>
- [Project Delivery](#).<sup>7</sup>

The Trenz Electronic FPGA Reference Designs are TCL-script based project. Command files for execution will be generated with "\_create\_win\_setup.cmd" on Windows OS and "\_create\_linux\_setup.sh" on Linux OS.

TE Scripts are only needed to generate the vivado project, all other additional steps are optional and can also be executed by Xilinx Vivado/Vitis GUI. For currently Scripts limitations on Win and Linux OS see: [Project Delivery Currently limitations of functionality](#)<sup>8</sup>

**!** **Caution!** Win OS has a 260 character limit for path lengths which can affect the Vivado tools. To avoid this issue, use Virtual Drive or the shortest possible names and directory locations for the reference design (for example "x:\<project folder>")

1. Run \_create\_win\_setup.cmd/\_create\_linux\_setup.sh and follow instructions on shell:

### \_create\_win\_setup.cmd/\_create\_linux\_setup.sh

```
-----Set design paths-----
-- Run Design with: _create_win_setup
-- Use Design Path: <absolute project path>
-----
-----TE Reference Design-----
-----
-- (0)  Module selection guide, project creation...prebuilt export...
-- (1)  Create minimum setup of CMD-Files and exit Batch
-- (2)  Create maximum setup of CMD-Files and exit Batch
-- (3)  (internal only) Dev
-- (4)  (internal only) Prod
-- (c)  Go to CMD-File Generation (Manual setup)
-- (d)  Go to Documentation (Web Documentation)
-- (g)  Install Board Files from Xilinx Board Store (beta)
-- (a)  Start design with unsupported Vivado Version (beta)
-- (x)  Exit Batch (nothing is done!)
-----
Select (ex.: '0' for module selection guide):
```

2. Press 0 and enter to start "Module Selection Guide"
3. Create project and follow instructions of the product selection guide, settings file will be configured automatically during this process.


<sup>5</sup> <https://wiki.trenz-electronic.de/display/PD/AMD+Development+Tools#AMDDDevelopmentTools-XilinxSoftware-BasicUserGuides>

<sup>6</sup> <https://wiki.trenz-electronic.de/display/PD/Vivado+Projects+-+TE+Reference+Design>

<sup>7</sup> <https://wiki.trenz-electronic.de/display/PD/Project+Delivery+-+Xilinx+devices>

<sup>8</sup> <https://wiki.trenz-electronic.de/display/PD/Project+Delivery+-+Xilinx+devices#ProjectDeliveryXilinxdevices-Currentlylimitationsoffunctionality>


- optional for manual changes: Select correct device and Xilinx install path on "design\_basic\_settings.cmd" and create Vivado project with "vivado\_create\_project\_gui mode.cmd"

 Note: Select correct one, see also [Vivado Board Part Flow](#)<sup>9</sup>

4. Create hardware description file (.xsa file) and export to prebuilt folder

**run on Vivado TCL (Script generates design and export files into "\prebuilt\hardware\")**


```
\prebuilt\hardware\")">  
TE::hw_build_design -export_prebuilt
```

 Using Vivado GUI is the same, except file export to prebuilt folder.

5. Generate Programming Files with Vitis

**run on Vivado TCL (Script generates applications and bootable files, which are defined in "test\_board\sw\_lib\apps\_list.csv")**

```
TE::sw_run_vitis -all  
TE::sw_run_vitis (optional; Start Vitis from Vivado GUI or start with TE  
Scripts on Vivado TCL)
```


 TCL scripts generate also platform project, this must be done manually in case GUI is used. See [Vitis](#)<sup>10</sup>

<sup>9</sup> <https://wiki.trenz-electronic.de/display/PD/Vivado+Board+Part+Flow>

<sup>10</sup> <https://wiki.trenz-electronic.de/display/PD/Vitis>

## 6 Launch


### 6.1 Programming

 Check Module and Carrier TRMs for proper HW configuration before you try any design. Reference Design is also available with prebuilt files. It's recommended to use TE prebuilt files for first launch.

Xilinx documentation for programming and debugging: [Vivado/Vitis/SDSoC-Xilinx Software Programming and Debugging](#)<sup>11</sup>

#### 6.1.1 Get prebuilt boot binaries

1. Run `_create_win_setup.cmd/_create_linux_setup.sh` and follow instructions on shell
2. Press 0 and enter to start "Module Selection Guide"
  - a. Select assembly version
  - b. Validate selection
  - c. Select create and open delivery binary folder

 Note: Folder "<project folder>\\_binaries\_<Article Name>" with subfolder "boot\_<app name>" for different applications will be generated

#### 6.1.2 QSPI-Boot mode

1. Connect **JTAG** and power on carrier with module
2. Set Boot Mode to **JTAG**
3. Open Vivado Project with "vivado\_open\_existing\_project\_guimode.cmd" or if not created, create with "vivado\_create\_project\_guimode.cmd"

**run on Vivado TCL (Script programs BOOT.bin on QSPI flash)**

```
TE::pr_program_flash -swapp hello_te0817
```

4. Set Boot Mode to **QSPI-Boot**
  - Depends on Carrier, see carrier TRM.

#### 6.1.3 SD-Boot mode

This does not work, because SD controller is not selected on PS.

#### 6.1.4 JTAG


Load configuration and Application with Vitis Debugger into device

<sup>11</sup> <https://wiki.trenz-electronic.de/display/PD/AMD+Development+Tools#AMDDDevelopmentTools-XilinxSoftwareProgrammingandDebugging>

## 6.2 Usage

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1. Prepare HW like described on section [Programming](#)(see page 14)
2. Connect UART USB (most cases same as JTAG)
3. Select QSPI as Boot Mode

 Note: See TRM of the Carrier, which is used.

4. Power On PCB

### **boot process**

1. Zynq Boot ROM loads FSBL from QSPI into OCM,
2. FSBL init PS, programs PL using the bitstream and loads Application into DDR,

## 7 System Design - Vivado

### 7.1 Block Design



Figure 1: Block Design

#### 7.1.1 PS Interfaces

Activated interfaces:

Type	Note
DDR	
QSPI	MIO
UART0	MIO
SWDT0..1	
TTC0..3	

Table 10: PS Interfaces



## 7.2 Constraints

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### 7.2.1 Basic module constraints

---

#### **\_i\_bitgen.xdc**

```
set_property BITSTREAM.GENERAL.COMPRESS TRUE [current_design]  
set_property BITSTREAM.CONFIG.UNUSEDPIN PULLNONE [current_design]
```

### 7.2.2 Design specific constraints

---

Not needed.

## 8 Software Design - Vitis

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For Vitis project creation, follow instructions from:

[Vitis](#)<sup>12</sup>

### 8.1 Application

---

Template location: "<project folder>\sw\_lib\sw\_apps\"

#### 8.1.1 zynqmp\_fsbl

---

TE modified 2021.2 FSBL

General:

- Modified Files: xfsbl\_main.c, xfsbl\_hooks.h/.c, xfsbl\_board.h/.c (search for 'TE Mod' on source code)
- Add Files: te\_xfsbl\_hooks.h/.c (for hooks and board)
- General Changes:
  - Display FSBL Banner and Device Name

#### 8.1.2 zynqmp\_fsbl\_flash

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TE modified 2021.2 FSBL

General:

- Modified Files: xfsbl\_initialisation.c, xfsbl\_hw.h, xfsbl\_handoff.c, xfsbl\_main.c
- General Changes:
  - Display FSBL Banner
  - Set FSBL Boot Mode to JTAG

#### 8.1.3 hello\_te0817

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Hello TE0817 is a Xilinx Hello World example as endless loop instead of one console output.

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<sup>12</sup> <https://wiki.trenz-electronic.de/display/PD/Vitis>

## 9 Additional Software

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No additional software is needed.

## 10 App. A: Change History and Legal Notices

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### 10.1 Document Change History

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To get content of older revision go to "Change History" of this page and select older document revision number.

Date	Docu ment Revisi on	Authors	Description
 2022-09-12	v.5(see page 6)	Manuela Strücker <sup>13</sup>	<ul style="list-style-type: none"><li>initial release</li></ul>
2022-09-06	v.4	Manuela Strücker	<ul style="list-style-type: none"><li>initial release</li></ul>
--	all	Manuela Strücker <sup>14</sup>	--

**Table 11: Document change history.**

### 10.2 Legal Notices

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### 10.3 Data Privacy

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Please also note our data protection declaration at <https://www.trenz-electronic.de/en/Data-protection-Privacy>

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<sup>13</sup> <https://wiki.trenz-electronic.de/display/~m.struecker>

<sup>14</sup> <https://wiki.trenz-electronic.de/display/~m.struecker>

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## 10.9 REACH, RoHS and WEEE

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<sup>15</sup> <http://guidance.echa.europa.eu/>

<sup>16</sup> <https://echa.europa.eu/candidate-list-table>

<sup>17</sup> <http://www.echa.europa.eu/>

Separate collection is the precondition to ensure specific treatment and recycling of waste electrical and electronic equipment and is necessary to achieve the chosen level of protection of human health and the environment in the European Union. Consumers have to actively contribute to the success of such collection and the return of waste electrical and electronic equipment. Presence of hazardous substances in electrical and electronic equipment results in potential effects on the environment and human health. The symbol consisting of the crossed-out wheeled bin indicates separate collection for waste electrical and electronic equipment.

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 2019-06-07